



SMD Comm X7R Flex, Ceramic, 1,000 pF, 5%, 50 VDC, X7R, SMD, MLCC, FT-CAP, Temperature Stable, 1206, 1.5 $\,\mathrm{mm}$



General Information	
Series	SMD Comm X7R Flex
Style	SMD Chip
Description	SMD, MLCC, FT-CAP, Temperature Stable
Features	FT-CAP, Temperature Stable
RoHS	Yes
Termination	Flexible Termination
Marking	No
AEC-Q200	No
Typical Component Weight	17 mg
Shelf Life	78 Weeks
MSL	1

1,000 pF

Dimensions	
Chip Size	1206
L	3.3mm +/-0.4mm
W	1.6mm +/-0.35mm
Т	0.78mm +/-0.20mm
S	1.5mm MIN
В	0.6mm +/-0.25mm

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Т	0.78mm +/-0.20mm
S	1.5mm MIN
В	0.6mm +/-0.25mm
Packaging Specifications	

L	3.3mm +/-0.4mm	Measurement Condition	1 kHz 1.0Vrms
W	1.6mm +/-0.35mm	Tolerance	5%
Т	0.78mm +/-0.20mm	Voltage DC	50 VDC
S	1.5mm MIN	Dielectric Withstanding Voltage	125 VDC
В	0.6mm +/-0.25mm	Temperature Range	-55/+125°C
		Temp. Coefficient	X7R
Packaging Specifications		Capacitance Change with	15%, 1kHz 1.0Vrms
Packaging		Reference to +25°C and 0 VDC Applied (TCC)	
r dekaging	T&R, 330mm, Plastic Tape		
Packaging Quantity	T&R, 330mm, Plastic Tape 10000		2.5% 1 kHz 1.0Vrms
5 5	, ,	Applied (TCC)	2.5% 1 kHz 1.0Vrms 3% Loss/Decade Hour: Referee Time is 1000 Hours

Specifications

Capacitance

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